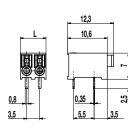
PCB connector for SMD

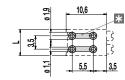
830-A-111-THR

Push-In connection





PCB Layout (Recommendation)



L = (No. of poles) x pitch L1 = (No. of poles - 1) x pitch Solder paste thickness: 0,15 - 0,2 mm solder pad, outside diameter: ø 1,9 mm

★ = Both solder pads of each pole can be connected together.

The PCB terminal block 830-A-111-THR with the pitch of 3,5 mm offers strong performance in the smallest space. The position of the entries in parallel to the printed circuit board enables the advantageous application within housings with external connection. Due to the very small space requirement and the white colour it is ideally suited to various applications in the lighting industry.

The front of the terminal is equipped with pushers to be handled with standard screwdrivers for the removal of the parallel connected conductors.

The easy to use spring system allows beside the use of 1 mm² solid wires also the connection of 0,75 mm² flexible by use of the pushers.

The advanced design of this high temperature resistant terminal allows in the area of the solder pins the free circulation of hot air in the convection oven during the reflow soldering process.

Part Numbers								
No. of poles	830-A-111-THR		Length	PU				
2	10.813.052		6,90	250				
3	10.813.053		10,40	250				
2	10.813.052.B00	(2 bar mag.)	6,90	150				
3	10.813.053.B00	(2 bar mag.)	10,40	100				

General Information

SMAR**T**CONN

RoHS

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Pitch	3,5 mm
No. of poles	2 + 3
Areas of application	Lighting technology, devices

Technical Data

Clamping Range	solid / flexible / A	solid / flexible / AWG			
	0,2 - 1,0 mm² / 0,2 - 0,75 mm² / 24 - 18 AWG				
Rated Cross Section	1 mm² (starr / sol	1 mm² (starr / solid) / 0,75 mm²			
Wire Stripping Length	7,5 mm ± 0,5 mn	7,5 mm ± 0,5 mm			
Overvoltage Category	111	III	II		
Pollution Severity Level	3	2	2		
Rated Voltage	160 V	160 V	320 V		
Rated Impulse Voltage	2,5 kV	2,5 kV	2,5 kV		
Rated Insulation Voltage	130 V acc. to EN	130 V acc. to EN 60998-1			
Rated Current		13,5 A apply to 1 mm ² solid 9 A apply to 0,75 mm ²			
Soldering process	Reflow solder	Reflow solder			
Hole in PCB	ø 1,1 mm				

Material

PA HT, white, V-0
CTI ≥ 600
1
-40°C up to 120°C; reflow solder temperature (Peak) max. 260°C (15-30 s)
Tin plated copper alloy
Stainless steel

Approvals

	Current	Voltage	Group	AWG	Nm
c AV ®us	6	300	В	24 - 18	

Options / Accessories

- Consecutive numbering
- Special marking according to drawing
- · Black colour on request
- Tape-on-Reel on request